# 2SB1320A

### Silicon PNP epitaxial planer type

For general amplification

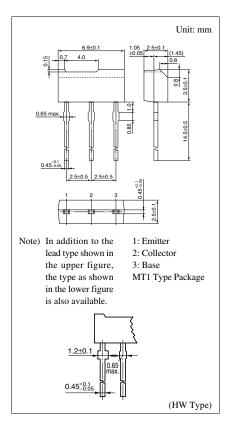
Complementary to 2SD1991A

#### Features

- $\bullet$  High forward current transfer ratio  $h_{FE}$
- Allowing supply with the radial taping

<b>— — — — — — — — — —</b>						
Symbol	Rating	Unit				
V <sub>CBO</sub>	-60	V				
V <sub>CEO</sub>	-50	V				
V <sub>EBO</sub>	-7	V				
I <sub>CP</sub>	-200	mA				
I <sub>C</sub>	-100	mA				
P <sub>C</sub>	400	mW				
Tj	150	°C				
T <sub>stg</sub>	-55 to +150	°C				
	$V_{CBO}$ $V_{CEO}$ $V_{EBO}$ $I_{CP}$ $I_{C}$ $P_{C}$ $T_{j}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $				





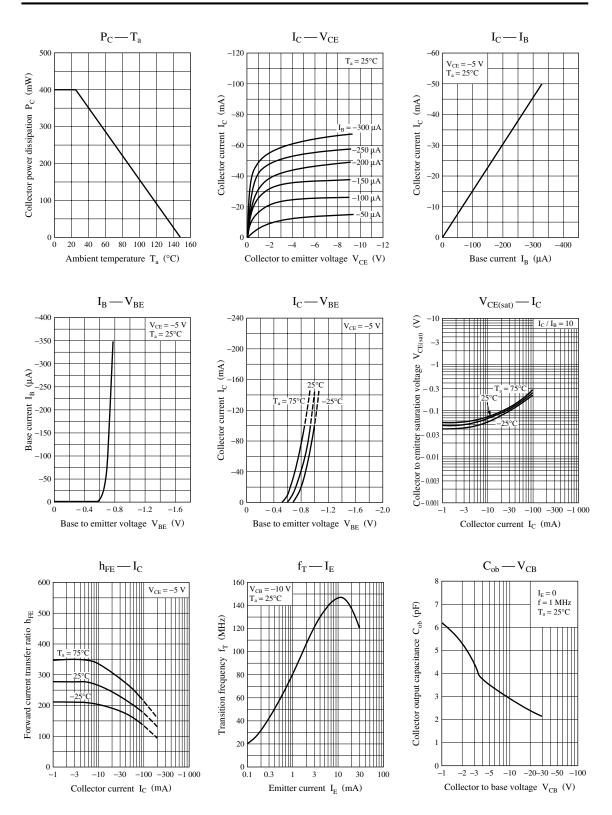
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

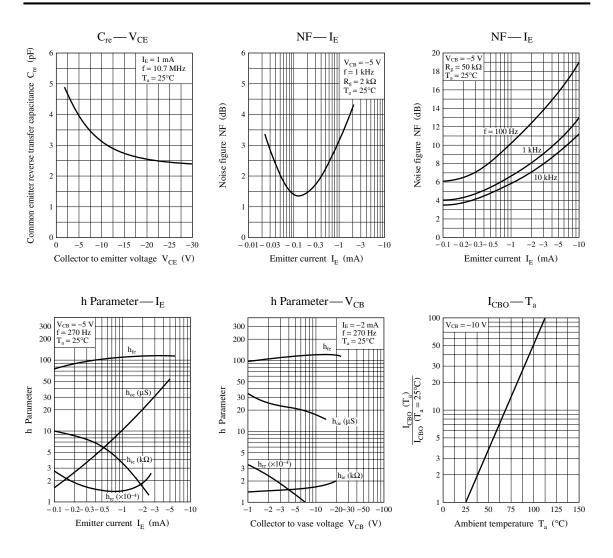
Parameter	Symbol	Conditions Min		Тур	Max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = -20 \text{ V}, I_E = 0$			-1	μΑ
	I <sub>CEO</sub>	$V_{CE} = -20 \text{ V}, I_B = 0$			-1	μΑ
Collector to base voltage	V <sub>CBO</sub>	$I_{\rm C} = -10 \ \mu A, \ I_{\rm E} = 0$	-60			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = -2  {\rm mA},  I_{\rm B} = 0$	-50			V
Emitter to base voltage	V <sub>EBO</sub>	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$	-7			V
Forward current transfer ratio *	h <sub>FE</sub>	$V_{CE} = -10 \text{ V}, I_C = -2 \text{ mA}$	160		460	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -100 \text{ mA}, I_{\rm B} = -10 \text{ mA}$			-1	V
Transition frequency	f <sub>T</sub>	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$		80		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		3.5		pF

Note) \*: Rank classification

Rank	Q	R	S	No-rank
h <sub>FE</sub>	160 to 260	210 to 340	290 to 460	160 to 460

Product of no-rank is not classified and have no indication for rank.





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